IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

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MAK	ITA e	+ a1	Atty. Ref.:	925-160			
Seria	l No.	09/667,527 TRADEMAN	Group:	2812			
Filed	•	September 22, 2000	Examiner:				
For:	ME	THOD OF PRODUCING SEMICONDUCT * * * * * * * * *	OR DEVICE * * * *				
P. O.	Box 1	oner for Patents 1450 , VA 22313-1450					
Sir:		INFORMATION DISCLOSURE	STATEMEN'	<u>T</u>			
\boxtimes	1.	PTO-1449 Pursuant to 37 CFR 1.97(b) [within 3 months of filing or prior to 1st Office	ce Action]	N/C			
	2.	Statement Pursuant to 37 CFR 1.97(c) [before Final Office Action or Allowance]		N/C			
	3.	Fee Payment Pursuant to 37 CFR 1.97(c) [before Final Office Action or Allowance]		\$180.00			
	4.	Pursuant to 37 CFR 1.97(d) [before Issue Fee payment]		\$180.00			
	The f	following are submitted in the above-identified	application in	compliance with 37			
C.F.R	. §§ 1.	97 and 1.98:					
\boxtimes	5.	A list of documents on Form PTO-1449 together with copies of each identified document and a translation or a concise explanation of each non-English language document is enclosed herewith.					
	\boxtimes	a) These references cited in a Taiwanese (Office Action 1	nailed June 9, 2003.			
This p	oaper is	s submitted in accordance with:					
\boxtimes	6.	37 CFR 1.97(b): [within 3 months of filing of	or prior to 1st (Office Action]			
	7.	37 CFR 1.97(c): [before Final Office Action or Allowance, whichever is earlier]; and					

a) The required Statement made in item 9 below; or **b**) The \$180.00 fee specified in 37 CFR \$1.17(p) for submission of this Information Disclosure Statement is authorized in item 10 below. 8. 37 CFR §1.97(d): [before issue fee payment]; and a) The fee (\$180.00) required by 37 CFR §1.17(p) is submitted herewith; and b) The required Statement is stated in item 9 below. 9. Statement under 37 CFR 1.97(e) \bigcap a) The undersigned attorney of record hereby certifies under 37 C.F.R. §1.97(e) that each item of information contained in this Information Disclosure Statement was first cited in a communication from a foreign patent office in a counterpart foreign application not more than three months prior to the filing of this Information Disclosure Statement (each item contained in this IDS was the first citation of that item by a foreign patent office in a counterpart foreign application which occurred no more than three months prior to the filing of this IDS); or b) No item of information contained in this Information Disclosure Statement was cited in a communication from a foreign patent office in a counterpart foreign application, and, to the knowledge of the person signing this Statement, after making reasonable inquiry, no item of information contained in this Statement was known to any individual designated in 37 CFR §1.56(c) more than three months prior to the filing of this Information Disclosure Statement. \boxtimes 10. Please charge all deficiency fees associated with the submission of this Information Disclosure Statement and any other fees applicable to this application to Deposit Account No. 14-1140. An original and one (1) copy of this document are enclosed. Respectfully submitted, NIXON & VANDERHYE P.C. By: Mare There July 10, 2003 H. Warren Burnam, Jr. Reg. No. 29,366 HWB:lsh 1100 North Glebe Road, 8th Floor Arlington, VA 22201-4714 Telephone: (703) 816-4000

MAKITA et al.

•Serial No. 09/667,527

Facsimile: (703) 816-4100

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	TRADEMIN	September 22,		2812				
*EXAMINER		U.S. PATEN	IT DOCUMENTS			FILING	DATE	
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	OTHER DOCL	JMENTS (including /	Author, Title, Date, Pe	ertinent pages.	etc.)	<u> </u>		
	Lee et al, "Fabrication of	of High-Mobility p-Cha	annel Poly-Si Thin Film	Transistors by	Self-Aligned	Metal-Ir	nduced	
	Lateral Crystallization",	IEEE Electron Device	E Letters, vol. 17, no. 8	, August 1996, p	p. 407-409			
	Bhat et al, "The Effects 1998, pp. 110-111	of MIC/MILC Interfac	e on the Performance	of MILC-THTs",	Device Res	earch Co	ont.,	
	Jin et al, "Performance	of Thin-Film Transisto	ors with Ultrathin Ni-MI	LC Polycrystallir	ne Silicon C	nannel L	ayers",	
	IEEE Election Device L					<u>-</u>		
 	 							
*Examiner			Date Considere	d T				
	reference considered, whether or r		vith MPEP 609; Draw line throug	h citation if not in confo	rmance and not	considered.	Include	
	ith next communication to application				Form PTO-FB-/			